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SE30AFB, SE30AFD, SE30AFG, SE30AFJ

Vishay General Semiconductor

Surface Mount ESD Capability Rectifiers



ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	3.0 A			
V _{RRM}	100 V, 200 V, 400 V, 600 V			
I _{FSM}	40 A			
V_F at I_F = 3.0 A (T_A = 125 °C)	0.86 V			
I _R	10 µA			
T _J max.	175 °C			
Package	SlimSMA (DO-221AC)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- · ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE30AFB	SE30AFD	SE30AFG	SE30AFJ	UNIT
Device marking code		S3B	S3D	S3G	S3J	
Maximum repetitive peak reverse voltage	V _{RRM}	100	200	400	600	V
Maximum DC forward current	I _F ⁽¹⁾	3.0				А
	I _F ⁽²⁾					
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	40				А
Operating junction and storage temperature range	T _J , T _{STG}	G -55 to +175				°C

Notes

⁽¹⁾ Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB

⁽²⁾ Free air, mounted on recommended copper pad area

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HALOGEN

FREE



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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST C	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.91	-	V
	I _F = 3.0 A			0.97	1.1	
	I _F = 1.5 A	– T _A = 125 °C		0.79	-	
	I _F = 3.0 A			0.86	0.98	
Reverse current	Datad \/	T _A = 25 °C	- I _R ⁽²⁾	-	10	μA
	Rated V _R	T _A = 125 °C		13	100	
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	1.5	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	19	-	pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	SYMBOL	SE30AFB	SE30AFD	SE30AFG	SE30AFJ	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾	125				°C/W	
	R _{0JM} ⁽²⁾	12				0/10	

Notes

 $^{(1)}$ Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(2)}$ Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25$ °C unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω	V _C	H3B	> 8 kV	

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SE30AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel	
SE30AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel	
SE30AFJHM3/6A ⁽¹⁾	0.032	6A	3500	7" diameter plastic tape and reel	
SE30AFJHM3/6B ⁽¹⁾	0.032	6B	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

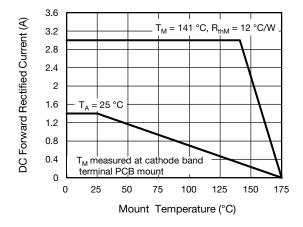


Fig. 1 - Maximum Forward Current Derating Curve

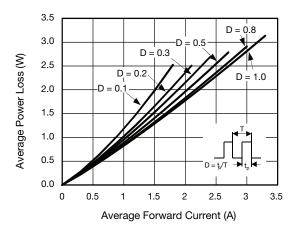


Fig. 2 - Forward Power Loss Characteristics

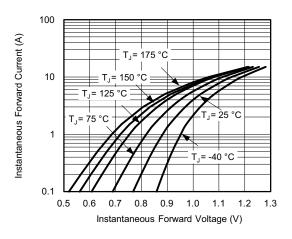


Fig. 3 - Typical Instantaneous Forward Characteristics

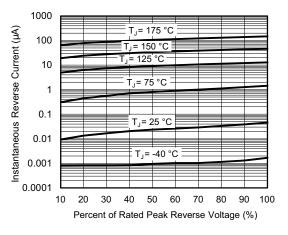


Fig. 4 - Typical Reverse Leakage Characteristics

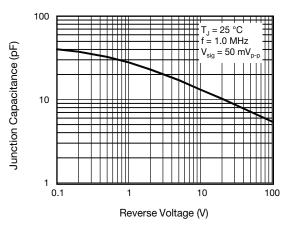


Fig. 5 - Typical Junction Capacitance

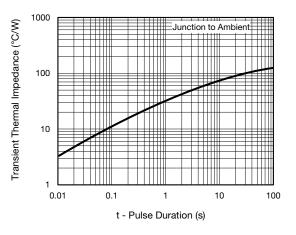
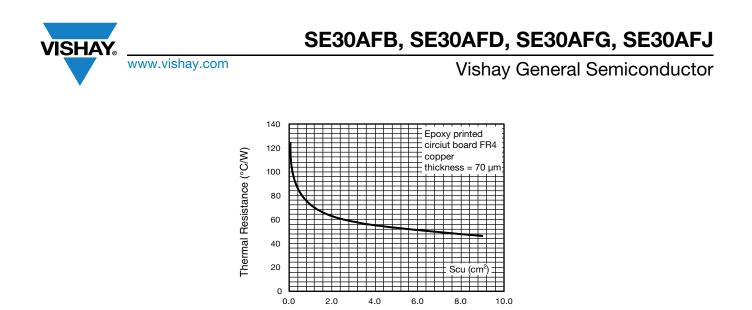


Fig. 6 - Transient Thermal Impedance

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 For technical questions within your region: DiodesAsia@vishay.com, DiodesEurope@vishay.com

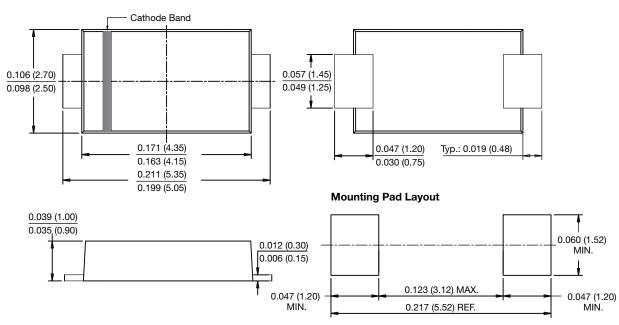
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Copper Pad Areas (cm²)

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



SlimSMA (DO-221AC)



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